

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Mr. Chiranjit Acharya	11/01/2006
RECEIVING PARTY DATA	
Name:	Sony Corporation
Street Address:	7-35 Kitashinagawa 6-Chome, Shinagawa-Ku
City:	Tokyo
State/Country:	JAPAN
Name:	Sony Electronics Inc.
Street Address:	1 Sony Drive
City:	Park Ridge
State/Country:	NEW JERSEY
Postal Code:	07656
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	11457064
CORRESPONDENCE DATA	
Fax Number:	(312)277-2397
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>	
Phone:	805-781-2865
Email:	tflebe@fitcheven.com
Correspondent Name:	Thomas F. Lebens
Address Line 1:	120 South LaSalle Street, Suite 1600
Address Line 4:	Chicago, ILLINOIS 60603
ATTORNEY DOCKET NUMBER:	86626
NAME OF SUBMITTER:	Thomas F. Lebens

CH \$40.00 11457064

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Total Attachments: 1
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ASSIGNMENT

WHEREAS, I, as an owner of certain new and useful improvements in METHOD AND SYSTEM FOR SUBSPACE BOUNDED RECURSIVE CLUSTERING OF CATEGORICAL DATA for which application for Letters Patent of the United States of America was filed on July 12, 2006.

AND WHEREAS, Sony Corporation, a Japanese corporation with offices at 7-35 Kitashinagawa 6-Chome, Shinagawa-Ku, Tokyo, Japan and Sony Electronics Inc. a Delaware corporation with offices at 1 Sony Drive, Park Ridge, New Jersey 07656 (hereinafter referenced as ASSIGNEES) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEES, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEES, as the assignees of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEES or its designee, as ASSIGNEES or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEES thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEES will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale;

And I hereby authorize and request my attorney(s) of record in this application to insert the execution date, serial number and filing date of this application in the spaces that follow: Serial Number: 11/457,064, Filing Date: July 12, 2006.

This assignment is being executed on the date indicated below.

Chiranjit Acharya
Chiranjit Acharya

Dated: 11/1/2006